PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kohnosuke Yamamoto	04/30/2013
Seiji Tsuji	04/30/2013
Kazuya Watanabe	04/30/2013

RECEIVING PARTY DATA

Name:	Toray Industries, Inc.	
Street Address:	1-1, Nihonbashi-Muromachi 2-chome	
Internal Address:	Chuo-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	103-8666	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14001358

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	HIP-13-1184 (308870-045)
NAME OF SUBMITTER:	Leslie J. Hood
Signature:	/LJH/
Date:	08/23/2013

Total Attachments: 1

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PATENT

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REEL: 031071 FRAME: 0694

<u>ASSIGNMENT</u>

WHEREAS, we, (1) Kohnosuke YAMAMOTO, (2) Seiji TSUJI and (3) Kazuya WATANABE, citizens of Japan, (1) - (3) residing at c/o Nagoya Plant, Toray Industries, Inc., 9-1, Oe-cho, Minato-ku, Nagoya-shi, Aichi 455-8502 Japan respectively, (hereinafter referred to as "the undersigned"), having made an invention entitled

METHOD FOR PRODUCING FRP

identified in International Application No. PCT/JP2012/054033, and US Application No. 14/001,358 , (DLA Piper is authorized to insert the Serial No. when known).

WHEREAS, TORAY INDUSTRIES, INC., with a head office at 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 103-8666 Japan,

(hereinafter referred to as "assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below.

April 30, 2013 Date

April 30, 2013

April 30, 2013 Date

(1) Kohnosuke Mamamoto
Kohnosuke YAMAMOTO

(2) Seiji Tsuji
Seiji TSUII

(3) Zaguya Ustanala
Kazuya WATANABE

PATENT REEL: 031071 FRAME: 0695

RECORDED: 08/23/2013